

Product Change Notification

Change Notification #: 118337-00
Change Title: Select Intel® Server System R2000WF Family, PCN 118337-00, Product Design, Removing a balun component located in L5K1 on boards
Date of Publication: July 02, 2021

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	July 17, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes to the item listed in table products affected below.

- Removing a balun component located in L5K1 on boards.



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R2312WFTZSR, Single	R2312WFTZSR	986053	K40015-011	H48104-960	K40015-012	H48104-961

PCN Revision History:

Date of Revision:

July 02, 2021

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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